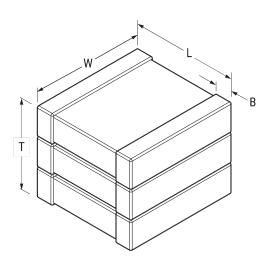


KONNEKT KC-LINK Auto COG, Ceramic, 0.045 uF, 10%, 2000 VDC, COG, 3-Chip Standard Orientation.



Click here for the 3D model.

Dimensions	
L	9.3mm +/-0.6mm
W	10.2mm +/-0.4mm
Т	7.7mm +/-0.6mm
В	1.27mm +/-0.4mm

Packaging Specifications			
Packaging	T&R, 180mm		
Packaging Quantity	75		

General Information		
Series	KONNEKT KC-LINK Auto COG	
Style	KONNEKT	
Description	KC-LINK with KONNEKT, SMD, MLCC, Ultra-Stable, Class I	
Features	Ultra-Stable	
RoHS	Yes	
Termination	Tin	
Qualifications	AEC-Q200	
AEC-Q200	Yes	
Typical Component Weight	3.3 g	
Notes	3-Chip Standard Orientation.	
Chip Size	3640-3	
MSL	1	

Specifications		
Capacitance	0.045 uF	
Measurement Condition	1kHz 1.0Vrms	
Capacitance Tolerance	10%	
·	2000 VDC	
Voltage DC		
Dielectric Withstanding Voltage	2400 VDC	
Temperature Range	-55/+150°C	
Temperature Coefficient	COG	
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms	
Dissipation Factor	0.1% 1 kHz 1.0Vrms	
Aging Rate	0% Loss/Decade Hour	
Insulation Resistance	22.2222 GOhms	

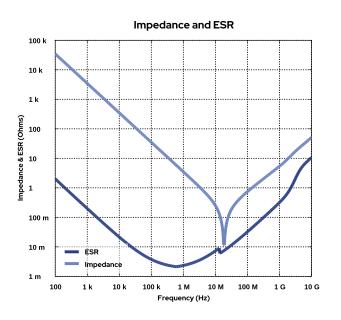
Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

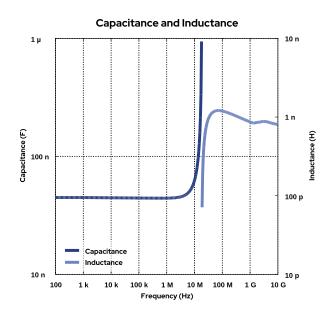


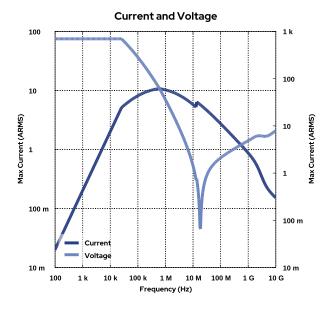
KONNEKT KC-LINK Auto COG, Ceramic, 0.045 uF, 10%, 2000 VDC, COG, 3-Chip Standard Orientation.

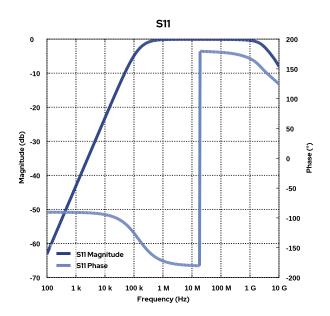
# **Simulations**

For the complete simulation environment please visit K-SIM.



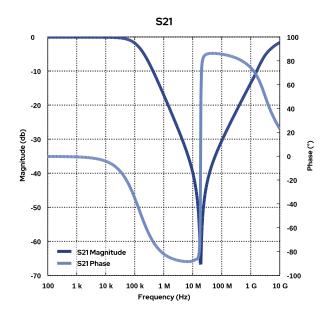


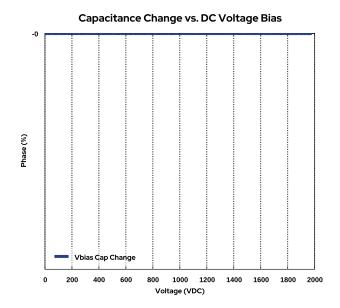






KONNEKT KC-LINK Auto COG, Ceramic, 0.045 uF, 10%, 2000 VDC, COG, 3-Chip Standard Orientation.







KONNEKT KC-LINK Auto COG, Ceramic, 0.045 uF, 10%, 2000 VDC, COG, 3-Chip Standard Orientation.

#### These are simulations.

This is not a specification!

The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

The responses shown do not represent a specified or implied maximum capability of the device for all applications.

- The ESR used for ripple "Ripple Current/Voltage vs. Frequency" plots is the ESR at ambient temperature.
- The ESR in the "Temperature Rise vs. Ripple Current" plots is adjusted to each incremental temperature rise before the power and ripple current is calculated.
- The effects shown herein are based on measured data from a multiple part sample of the parts in question.
- Ripple capability of this device will be factored by thermal resistance (Rth) created by circuit traces (addi affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

  The peak voltages generated in the "Temperature Rise vs. Combined Ripple Currents" plot are calculated for each frequency and are not combined with voltages generated at any other
- Please consult with the catalog or field applications engineer for maximum capability of the device in specific applications.

All product information and data (collectively, the "Information") are subject to change without notice.

KEMET K-SIM is designed to simulate behavior of components with respect to frequency, ambient temperature, and DC bias levels. The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation effects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

All Information given herein is believed to be accurate and reliable, but is presented without guarantee, warranty, or responsibility of any kind, expressed or implied. Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute – and we specifically disclaim – any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

If you have any questions please contact K-SIM.